|--|

SEAT No.:			
[Total	No. of Pages	:	2

## P1865

## [4859]-1048 B.E. (Electronics)

			D.E. (Electronics)				
			<b>ELECTRONICS SYSTEM DESIGN</b>				
		(2	2012 Course) (Semester-I) (End Sem) (404202)				
Time : 2 <sup>1</sup> / <sub>2</sub> Hours] [Max. M							
Instri	uctio	ns to i	the candidates:				
	1)	Ansı Q. (8	wer the questions Q. (1) or Q. (2), Q. (3) or Q. (4), Q. (5) or Q. (6), Q. (78).	7) 01			
	<i>2)</i>	_	ires to the right indicate full marks.				
	3)		t diagrams must be drawn wherever necessary.				
	<i>4)</i> <i>5)</i>		of electronic calculator is allowed. ume suitable data, if necessary.				
	-)	1 255 6					
Q1)	a)	-	lain industrial product design with the help of case study in de lain their classification.	tail. [ <b>8</b> ]			
	b)	Exp	lain the following terms of DAC:	[6]			
		i)	Resolution.				
		ii)	Maximum sampling rate.				
		iii)	Total harmonic distortion and noise.				
	c)		at are the factors affecting on selection of buses and protocol speed electronics product.	s in [6]			
			OR				
Q2)	a)	Explain the different soldering techniques used in large scale product and high reliability product.					
	b)	Wha	at are different DAC techniques? Compare on the basis of accur	acy.			
	c)	Des	ign and explain Interfacing of LCD with microcontroller.	[6]			
<b>Q</b> 3) :	a)	Exp	lain different stages of software development in electronic prod	uct. [ <b>8</b> ]			
	b)	Wri	te a note on debugging tools and techniques for software design	ո.[8]			
			OR				

Q4)	a)	_	lain the factors affecting on the choice of assembly language a level language with example.	nd [ <b>8]</b>
	b)	Writ	te note on:	[8]
		i)	Compiler.	
		ii)	Simulator.	
Q5)	a)		at are the different PCB Design issues for high speed integrate uits. Explain in detail.	ed [0]
	b)	Expl	lain the importance of shielding and grounding.	[8]
			OR	
Q6)	a)		at are the different PCB Design issues of analog and mixed signuits. Explain in details.	nal . <b>0]</b>
	b)	List	different EMI/EMC standards. Explain its important.	[8]
Q7)	a)	Expl analy	lain how debugging of electronics circuit is carried out by log	gic [ <b>8]</b>
	b)	Expl	lain with suitable example of vibration testing.	[8]
			OR	
Q8)	a)	_	cify with justification the choice of environmental testing to be carrion following electronic product:	ed [ <b>8]</b>
		i)	Washing Machine.	
		ii)	ECG.	
	b)	Writ	te a notes on:	[8]
		i)	Digital storage oscilloscope.	
		ii)	Mixed single oscilloscopes.	

••••